

# Normally – OFF Silicon Carbide Super Junction Transistor

# $V_{DS}$ = 650 V $I_{D}$ = 15 A $R_{DS(ON)}$ = 105 m $\Omega$

#### **Features**

- 250 °C maximum operating temperature
- Temperature independent switching performance
- Gate oxide free SiC switch
- Suitable for connecting an anti-parallel diode
- · Positive temperature coefficient for easy paralleling
- Low gate charge
- · Low intrinsic capacitance

#### **Package**

• RoHS Compliant





TO - 257 (Hermetic Package)

#### **Advantages**

- Low switching losses
- · Higher efficiency
- High temperature operation
- High short circuit withstand capability

## **Applications**

- Ideal for Aerospace and Defense Applications
- Down Hole Oil Drilling, Geothermal Instrumentation
- Hybrid Electric Vehicles (HEV)
- Solar Inverters
- Switched-Mode Power Supply (SMPS)
- Power Factor Correction (PFC)
- Induction Heating
- Uninterruptible Power Supply (UPS)
- Motor Drives

#### Maximum Ratings at T<sub>i</sub> = 250 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit
Drain – Source Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V	650	V
Continuous Drain Current	I <sub>D</sub>	T <sub>C</sub> = 155 °C	15	Α
Gate Peak Current	I <sub>GM</sub>		5	Α
Reverse Gate – Source Voltage	$V_{GS}$		200	V
Reverse Drain – Source Voltage	$V_{DS}$		40	V
Power Dissipation	P <sub>tot</sub>	T <sub>C</sub> = 25 °C	22	W
Operating and Storage Temperature	$T_{j},T_{stg}$		-55 to 250	°C

#### Electrical Characteristics at $T_j = 250$ °C, unless otherwise specified

Parameter	Symbol	Conditions -	Values		11		
		Conditions	min.	typ.	max.	Unit	
On Characteristics							
		$I_D = 15 \text{ A}, I_G = 500 \text{ mA}, T_j = 25 ^{\circ}\text{C}$		1.5			
Drain – Source On Voltage	$V_{DS(ON)}$	$I_D$ = 15 A, $I_G$ = 1000 mA, $T_j$ = 175 °C		2.4		V	
		$I_D = 15 \text{ A}, I_G = 1000 \text{ mA}, T_j = 250 ^{\circ}\text{C}$		3.6			
		$I_D = 15 \text{ A}, I_G = 500 \text{ mA}, T_j = 25 ^{\circ}\text{C}$		105			
Drain – Source On Resistance	$R_{DS(ON)}$	$I_D = 15 \text{ A}, I_G = 1000 \text{ mA}, T_j = 175 °C$		180		mΩ	
		$I_D = 15 \text{ A}, I_G = 1000 \text{ mA}, T_j = 250 ^{\circ}\text{C}$		290			
Gate Forward Voltage	$V_{GS(FWD)}$	I <sub>G</sub> = 500 mA, T <sub>j</sub> = 25 °C		3		V	
		$I_G = 500 \text{ mA}, T_j = 250 \text{ °C}$		2.6		V	
DC Current Gain	β	$V_{DS} = 5 \text{ V}, I_{D} = 20 \text{ A}, T_{j} = 25 ^{\circ}\text{C}$		115			
		$V_{DS} = 5 \text{ V}, I_{D} = 20 \text{ A}, T_{j} = 250 ^{\circ}\text{C}$		75			
Off Characteristics							
·	·	$V_R = 650 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 25 \text{ °C}$	•	1			
Drain Leakage Current	I <sub>DSS</sub>	$V_R = 650 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 175 ^{\circ}\text{C}$		7		μΑ	
		$V_R = 650 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 250 \text{ °C}$		45			



# Electrical Characteristics at T<sub>j</sub> = 250 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values		11-14	
		Conditions	min.	typ.	max.	Unit
Dynamic Characteristics						
Input Capacitance	$C_{iss}$	V <sub>DS</sub> = 35 V, V <sub>GS</sub> = 0 V, f = 1 MHz, T <sub>vj</sub> = 25 °C		1534		pF
Output Capacitance	$C_{oss}$			157		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			157		pF
Switching Characteristics						
Turn On Delay Time	$t_{d(on)}$	$V_{DD} = 400 \text{ V}, \text{ I}_D = 20 \text{ A}, \\ R_{G(on)} = R_{G(off)} = 22 \Omega, \\ V_{GS} = -8/15 \text{ V}, T_j = 175 \text{ °C} \\ \text{Refer to Figure 10 for gate drive} \\ \text{current waveforms}$		5		ns
Rise Time	t <sub>r</sub>			37		ns
Turn Off Delay Time	$t_{d(off)}$			68		ns
Fall Time	t <sub>f</sub>			78		ns
Turn-On Energy Per Pulse	E <sub>on</sub>			66		μJ
Turn-Off Energy Per Pulse	E <sub>off</sub>			365		μJ
Total Switching Energy	E <sub>ts</sub>			431		μJ
Turn On Delay Time	$t_{d(on)}$	$V_{DD} = 400 \text{ V}, I_D = 10 \text{ A}, \\ R_{G(on)} = R_{G(off)} = 22 \Omega, \\ V_{GS} = -8/15 \text{ V}, T_j = 250 ^{\circ}\text{C} \\ \text{Refer to Figure 10 for gate drive} \\ \text{current waveforms}$		7		ns
Rise Time	t <sub>r</sub>			38		ns
Turn Off Delay Time	$t_{d(off)}$			85		ns
Fall Time	t <sub>f</sub>			86		ns
Turn-On Energy Per Pulse	E <sub>on</sub>			64		μJ
Turn-Off Energy Per Pulse	E <sub>off</sub>			395		μJ
Total Switching Energy	E <sub>ts</sub>			459		μJ
				•		
Thermal Characteristics Thermal resistance, junction - case	R <sub>thJC</sub>			1.4		°C/W

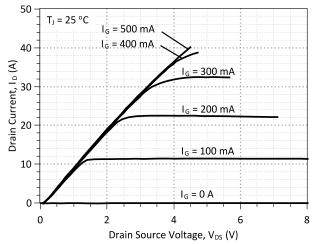


Figure 1: Typical Output Characteristics at 25 °C

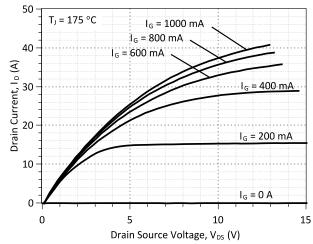


Figure 2: Typical Output Characteristics at 175 °C



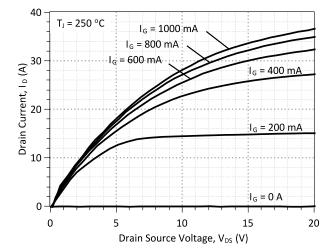


Figure 3: Typical Output Characteristics at 250 °C

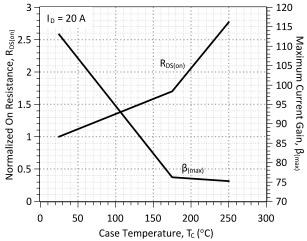


Figure 5: Normalized On-Resistance and Current Gain vs. Temperature

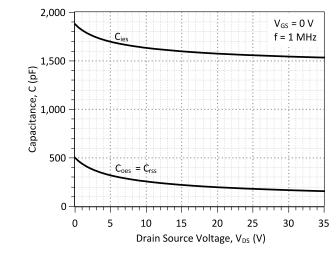


Figure 7: Typical Capacitance vs Drain-Source Voltage

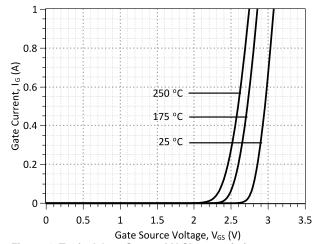


Figure 4: Typical Gate Source I-V Characteristics vs. Temperature

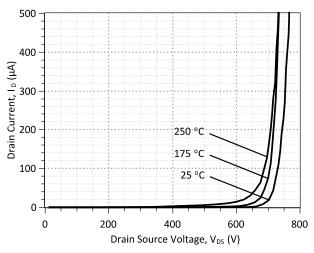


Figure 6: Typical Blocking Characteristics

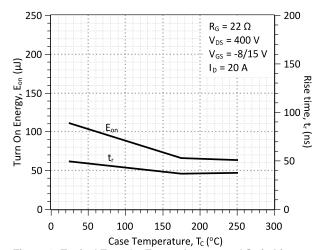


Figure 8: Typical Turn On Energy Losses and Switching Times vs. Temperature

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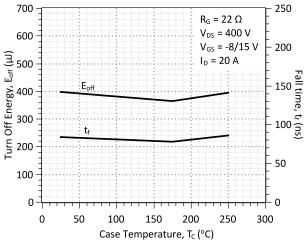


Figure 9: Typical Turn Off Energy Losses and Switching Times vs. Temperature

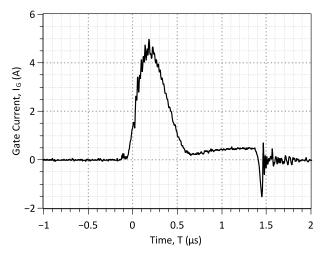
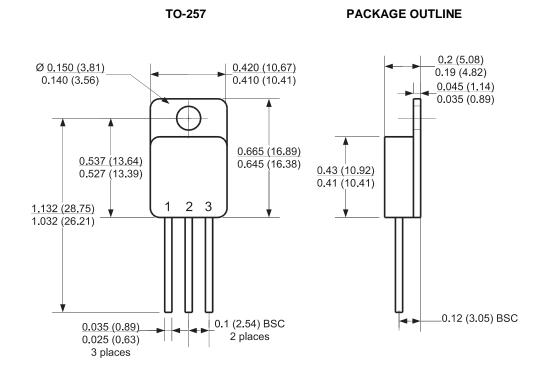


Figure 10: Typical Gate-Source Switching Waveforms

### **Package Dimensions:**



- CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
   DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS



Revision History					
Date	Revision	Comments	Supersedes		
2012/08/24	0	Initial release			

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